L	Hits	Search Text	DB	Time stamp
Number 1	11865	chip near (capacitor\$1 or resistor\$1)	USPAT; US-PGPUB;	2004/08/12 08:55
			EPO; JPO; DERWENT; IBM TDB	00:55
2	1822826	terminal\$1 or termination	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:17
3	2317	<pre>(chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination)</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:18
4	400	<pre>plat\$3 same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:18
5	37375	electroless\$2	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:18
6	8	<pre>(plat\$3 same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination))) same electroless\$2</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/12 08:23
7	4	<pre>(clean\$3 or activat\$3 or cataly\$5) same (plat\$3 same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination)))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/12 09:26
8	0	<pre>(clean\$3) same (plat\$3 same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination)))</pre>	USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:31
9	7	<pre>(clean\$3) same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:27
10	28	(clean\$3)and (plat\$3 same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination)))	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:31
11	28	<pre>(clean\$3) and (plat\$3 same ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination)))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:38
12	10	<pre>(nickel adj oxide\$1) and ((chip near (capacitor\$1 or resistor\$1)) same (terminal\$1 or termination))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 08:40
13	1365	(nickel adj oxide\$1) same (clean\$3 or polish\$3 or remov\$3)	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT;	2004/08/12 09:27
14	3	<pre>(chip near (capacitor\$1 or resistor\$1)) and ((nickel adj oxide\$1) same (clean\$3 or polish\$3 or remov\$3))</pre>	IBM_TDB USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2004/08/12 08:43

Search History

8/12/04 9:51:11 AM

[ 1 r				
15	192	(multi-layered or laminated) near	USPAT;	2004/08/12
		(capaciotr\$1 or resistor\$1)	US-PGPUB;	08:44
1			EPO; JPO;	
			DERWENT;	
1.5			IBM_TDB	
16	13		USPAT;	2004/08/12
1		((multi-layered or laminated) near	US-PGPUB;	08:46
		(capaciotr\$1 or resistor\$1))	EPO; JPO;	
			DERWENT;	
			IBM_TDB	
17	136115	(terminal\$1 or termination) near	USPAT;	2004/08/12
ļ		(elctrode\$1 or end\$1 or contact\$1)	US-PGPUB;	08:54
İ			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
18	1	jp-62242324-\$.did.	USPAT;	2004/08/12
			US-PGPUB;	08:49
			EPO; JPO;	
			DERWENT;	
1.0			IBM_TDB	
19	215399	(external or terminal\$1 or termination)	USPAT;	2004/08/12
		near (electrode\$1 or end\$1 or contact\$1)	US-PGPUB;	08:55
			EPO; JPO;	
			DERWENT;	
			IBM_TDB	
20	16808	(condensor\$1 or varistor\$1 or capacitor\$1	USPAT;	2004/08/12
		or resistor\$1) same ((external or	US-PGPUB;	08:57
		terminal\$1 or termination) near	EPO; JPO;	
		(electrode\$1 or end\$1 or contact\$1))	DERWENT;	
			IBM_TDB	
21	337	((condensor\$1 or varistor\$1 or	USPĀT;	2004/08/12
		capacitor\$1 or resistor\$1) same	US-PGPUB;	08:58
		((external or terminal\$1 or termination)	EPO; JPO;	
		near (electrode\$1 or end\$1 or	DERWENT;	1
		contact\$1))) and (electroless\$2 or	IBM TDB	
		non-electrolytic or	_	
		non-electroconductive)		
22	2	(((condensor\$1 or varistor\$1 or	USPAT;	2004/08/12
İ		capacitor\$1 or resistor\$1) same	US-PGPUB;	09:26
		((external or terminal\$1 or termination)	EPO; JPO;	
ļ		near (electrode\$1 or end\$1 or	DERWENT;	
ĺ	ļ	contact\$1))) and (electroless\$2 or	IBM_TDB	
		non-electrolytic or		
		non-electroconductive)) and ((nickel adj		
		oxide\$1) same (clean\$3 or polish\$3 or		
		remov\$3))		
23	261	(((condensor\$1 or varistor\$1 or	USPAT;	2004/08/12
		capacitor\$1 or resistor\$1) same	US-PGPUB;	09:48
		((external or terminal\$1 or termination)	EPO; JPO;	
		near (electrode\$1 or end\$1 or	DERWENT;	
		contact\$1))) and (electroless\$2 or	IBM_TDB	
		non-electrolytic or	_	
}		non-electroconductive)) and ((nickel adj		
		oxide\$1) or (clean\$3 or polish\$3 or		
	. [	remov\$3))		
24	26		USPAT;	2004/08/12
		or 6310757.pn. or 6478882.pn. or	US-PGPUB;	09:50
		5805409.pn. or 6070787.pn. or 6090435.pn.	EPO; JPO;	
		or 6124769.pn. or 6232144.pn. 5311651.pn.	DERWENT;	
	, ,	or 4811162.pn. or 4604676.pn.	IBM TDB	
				L